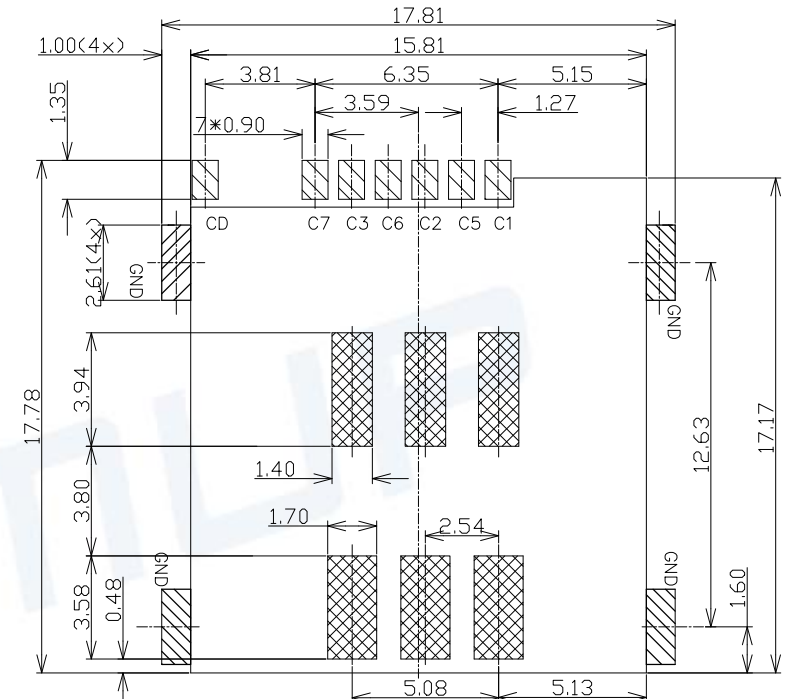
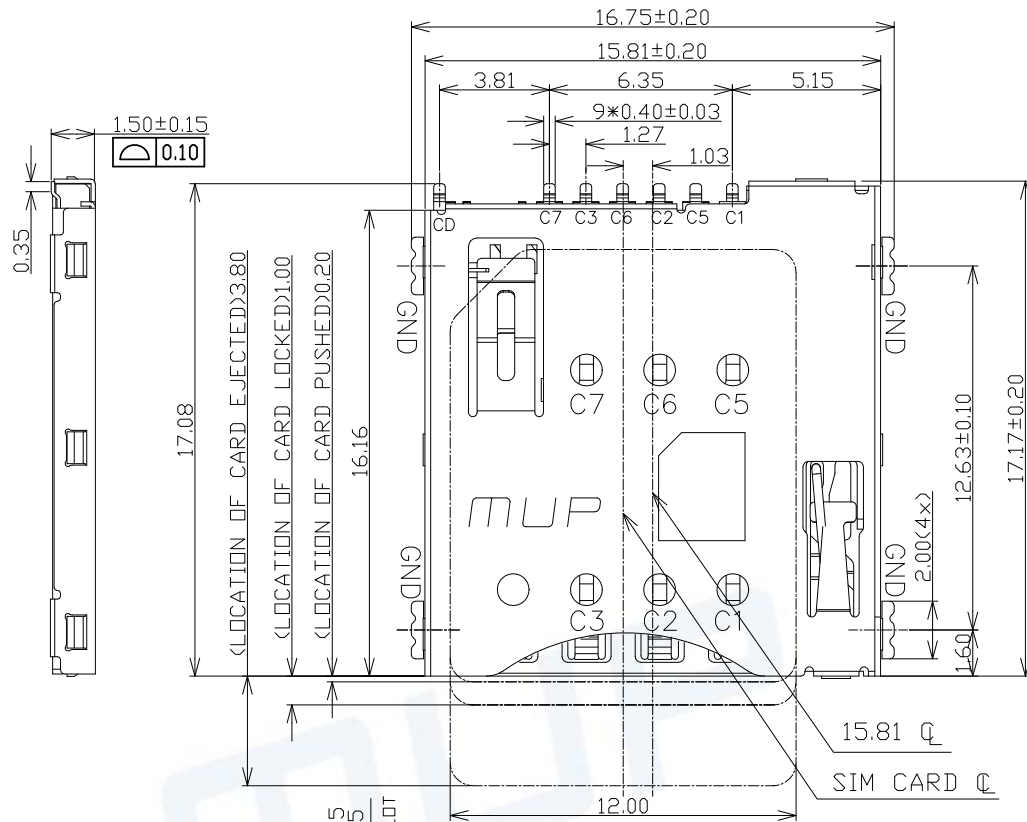


REV.	DESCRIPTION OF REVISIONS	APPR.	DRAW.	RELEASE	DATE
X1	NEW REVISION				Jun.23.2017
X2					



PAD AREA
 CONNECTOR OUTLINE COMPONENT SIDE(TOLERANCE ±0.05)
 NO PATTERN AND VIA HOLE IN THIS AREA

ITEM	PART NAME	Q'TY	MATERIAL	FINISH
1	HOUSING	1	Hi-temp Thermoplastic	Black UL94V-0
2	DATA CONTACT	6	Copper Alloy	Contact area:Gold plated
3	CD SWITCH	1	Copper Alloy	Contact area:Gold plated
4	SHELL	1	Stainless Steel	SMT area:Gold plated
5	SPRING	1	SWP	
6	GUIDE	1	Hi-temp Thermoplastic	Black UL94V-0
7	LINK	1	Stainless Steel	

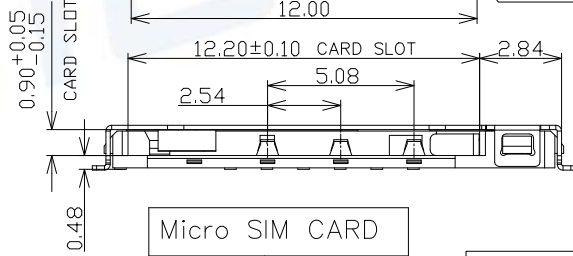
TECHNICAL CHARACTERISTICS

1.General Characteristics
 Dimensions: 15.81LX17.17WX1.50H mm
 Weight: Approx 0.4±0.1g
 Durability: 1500 cycles min.

2.Electrical Characteristics
 Contact resistance;
 Date Contact: 150mΩ max
 CD Switch: 500mΩ max
 Insulation resistance: >1000MΩ/500V DC

3.Solderability
 Vapor phase: 215°C, 30sec.Max
 IR reflow: 260°C, 5sec.Max
 Manual soldering: 370°C, 3sec.Max

4.Environmental Characteristics
 Operating temperature: -40°C~+85°C
 Operating humidity: 10%~+95%RH



Micro SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	VPP
C7	I/O
C8	Reserved

ELECTRIC FUNCTION	DETECT SWITCH
WITHOUT CARD	CLOSED
CARD INSERTED	OPEN



Unless otherwise specified, other tolerance are:

X	±0.35	X'	±5'
X.X	±0.25	X.X'	±4'
X.XX	±0.15	X.XX'	±3'
X.XXX	±0.10	X.XXX'	±2'

MUP® MUP INDUSTRIAL CO.,LTD.

NAME: MicroSIM Card Connector	
MODEL NO: MUP-C792-3	
TYPE : H1.50 6PIN Normally Cloes	
PROJ.	DWG NO.:
UNIT	DRAWN
SCALE	CHECKED
CUSTOMER DRAWING	APPROVAL
mm	Henry Jun.23.2017
1:1	Henry Jun.23.2017
	Simon Jun.23.2017
	SHEET
	REVISION
	1/1
	X1